

Power Inductor for Surface Mounting

PSM-0730 Series

Inductance Range: 0.1μH~22μH Temperature Range: −40℃~+125℃

Dimensions (mm)



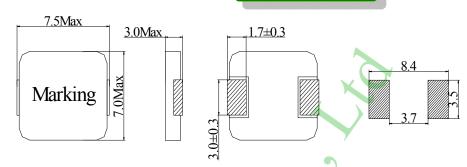
Features:

- ★Quantity / Reel:1000pcs
- ★High performance (Isat) realized by metal dust core.
- ★Low profile: Thickness max. 3.0mm
- ★Low loss realized with low DCR
 Capable of corresponding high frequency (1MHz)
- ★Design to customer requirement

Application:

- ★DC/DC converter for CPU in Notebook PC
- ★Thin type on-board power supply module for exchangerVRM for server

Electrical Characteristics:



Pb Cd Cr+6 PBBs PBDEs ND ND ND ND

Configuration:

- (1) (2) (3) (4)
- (1)Product Code(P&Z for SMD type)
- (2)Series Code(Typical dimension)
- (3)Inductance: $1R0 = 1.0 \mu H$
- (4) Inductance tolerance: $M = \pm 20\%$, $L = \pm 15\%$, $K = \pm 10\%$

P&Z Part Number	L0 @ (0A) Inductance (μΗ) ±20%	DCR(mΩ)		Heat Rating Current DC Amps. Idc (A)	Saturation Current DC Amps. Isat (A)
		Typical	Maximum	Typical	Typical
PSM0730-R10M	0.10	1.5	1.7	32.5	60.0
PSM0730-R22M	0.22	2.5	2.8	23.0	40.0
PSM0730-R33M	0.33	3.5	3.9	20.0	30.0
PSM0730-R47M	0.47	4.0	4.2	17.5	26.0
PSM0730-R56M	0.56	4.7	5.0	16.5	25.5
PSM0730-R68M	0.68	5.0	5.5	15.5	25.0
PSM0730-R82M	0.82	6.7	8.0	13.0	24.0
PSM0730-1R0M	1.0	9.0	10.0	11.0	22.0
PSM0730-1R5M	1.5	14.0	15.0	9.0	18.0
PSM0730-2R2M	2.2/	18.0	20.0	8.0	14.0
PSM0730-3R3M	3.3	28.0	30.0	6.0	13.5
PSM0730-4R7M	4.7	37.0	40.0	5.5	10.0
PSM0730-6R8M	6.8	54.0	60.0	4.5	8.0
PSM0730-8R2M	8.2	54.0	60.0	4.5	6.0
PSM0730-100M	10	62.0	68.0	4.0	5.5
PSM0730-220M	22	129.0	135.0	2.9	3.5

- ★If you require another part number please contact with us.
- 1.All test data is referenced to 25 ℃ ambient. Operating. Temperature Range -55 ℃ to + 125 ℃. Test Condition:100KHz, 1.0Vrms.
- 2.Idc:DC current (A) that will cause an approximate \triangle °CT of 40 °C.
- 3.Isat:DC current (A) that will cause Lo to drop approximately 30%.
- $4. The part temperature (ambient + temp \ rise \) \ should \ not \ exceed \ 125\,^{\circ}\!\!C \ under \ worse \ case \ operating \ conditions. \ Circuit \ design \ , \ component \ placement,$

PWB trace size and thickness, airflow and other cooling provision all affect the part temperature. Part temperature should be verified in the end.